

DMTH10H015SPS 100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET

PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on) Max	I _D Tc = +25°С
4001/	14.5mΩ @ V _{GS} = 10V	56A
100V	19.5mΩ @ V _{GS} = 6V	49A

Description and Applications

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize $R_{DS(ON)}$ yet maintain superior switching performance. This device is ideal for use in:

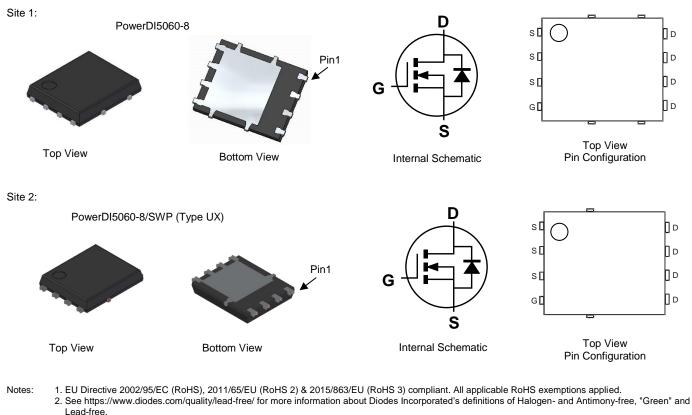
- Motor controls
- DC-DC converters
- Power managements

Features

- Rated to +175°C—Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production— Ensures More Reliable and Robust End Application
- Thermally Efficient Package—Cooler Running Applications
- Low RDS(ON)—Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An automotive-compliant part is available under separate datasheet (<u>DMTH10H015SPSQ</u>)

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)



3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

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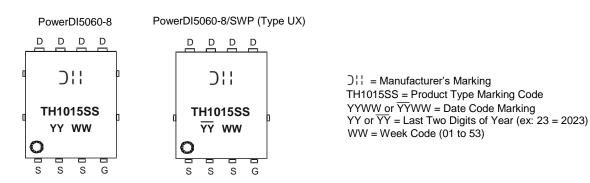


Ordering Information (Note 4)

Part Number	Package	Packing		
Fait Nulliber	Fackage	Qty.	Carrier	
DMTH10H015SPS-13	PowerDI5060-8	2,500	Tape & Reel	
DMTH10H015SPS-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note: 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			Vdss	100	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current (Note 5) V _{GS} = 10V	lo	56 39	A		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			Ідм	120	А
Maximum Continuous Body Diode Forward Current (Note 5)			ls	56	А
Avalanche Current (Note 7), L = 3mH			las	7.5	А
Avalanche Energy (Note 7), L = 3mH			E _{AS}	85	mJ
Avalanche Current, L = 0.1mH			las	15.8	А
Avalanche Energy, L = 0.1mH			Eas	12.5	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.7	W
Thermal Resistance, Junction to Ambient (Note 6)		RθJA	55	°C/W
Total Power Dissipation (Note 5)	Tc = +25°C	PD	94	W
Thermal Resistance, Junction to Case (Note 5)		Rejc	1.6	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes: 5. Thermal resistance from junction to soldering point (on the exposed drain pad).

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

7. Guaranteed by design. Not subject to product testing.



Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

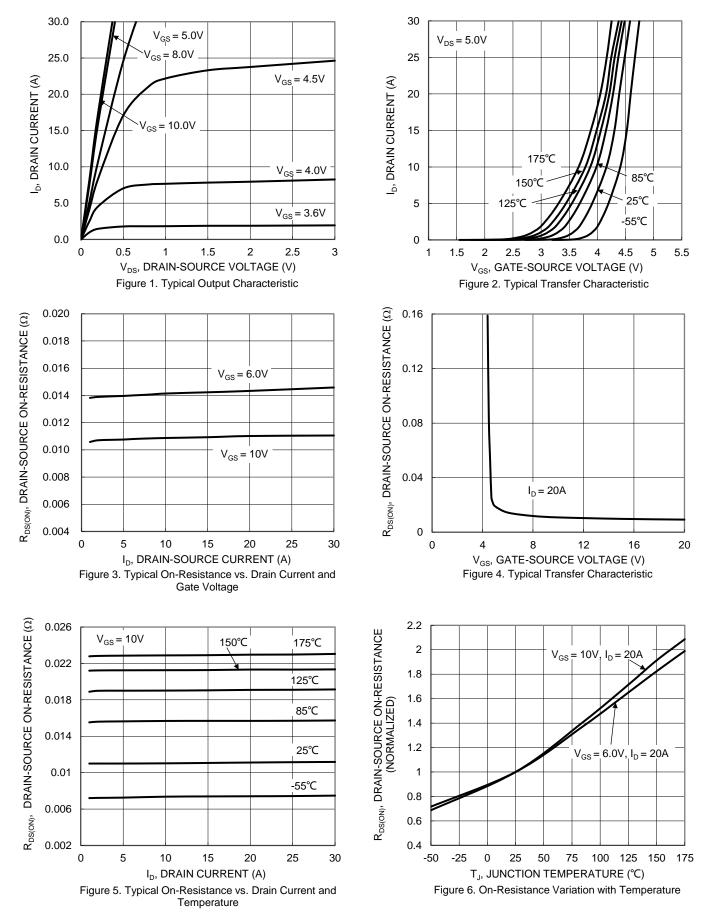
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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BVDSS	100	_	_	V	$V_{GS} = 0V, I_D = 1mA$
Zero Gate Voltage Drain Current	IDSS		_	1	μA	$V_{DS} = 80V, V_{GS} = 0V$
Gate-Source Leakage	lgss		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	2	—	4	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance			11.3	14.5	mΩ	V _{GS} = 10V, I _D = 20A
Static Dialit-Source Off-Resistance	RDS(ON)		14.7	19.5	11152	$V_{GS} = 6V, I_D = 20A$
Diode Forward Voltage	V _{SD}		0.9	1.3	V	$V_{GS} = 0V, I_{S} = 20A$
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	Ciss	_	2343	_	pF	$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz
Output Capacitance	Coss	_	487	_		
Reverse Transfer Capacitance	Crss		26	—		
Gate Resistance	Rg		0.69	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge	Qg		30.1	_		
Gate-Source Charge	Q _{gs}	_	7.5	_	nC	V _{DD} = 50V, I _D = 10A, V _{GS} = 10V
Gate-Drain Charge	Q _{gd}	_	6.5	_		
Turn-On Delay Time	tD(ON)	_	9.8	_		
Turn-On Rise Time	t _R	_	7.8	_	ns	$\label{eq:VDD} \begin{split} V_{DD} &= 50V, \ V_{GS} = 10V, \\ I_D &= 10A, \ R_G = 6\Omega \end{split}$
Turn-Off Delay Time	tD(OFF)		22.5	_		
Turn-Off Fall Time	tF	_	9.6			
Reverse Recovery Time	t _{RR}		43.1		ns	
Reverse Recovery Charge	QRR	_	65.1		nC	$I_F = 10A, di/dt = 100A/\mu s$

Notes:

Guaranteed by design. Not subject to product testing.
 Short duration pulse test used to minimize self-heating effect.



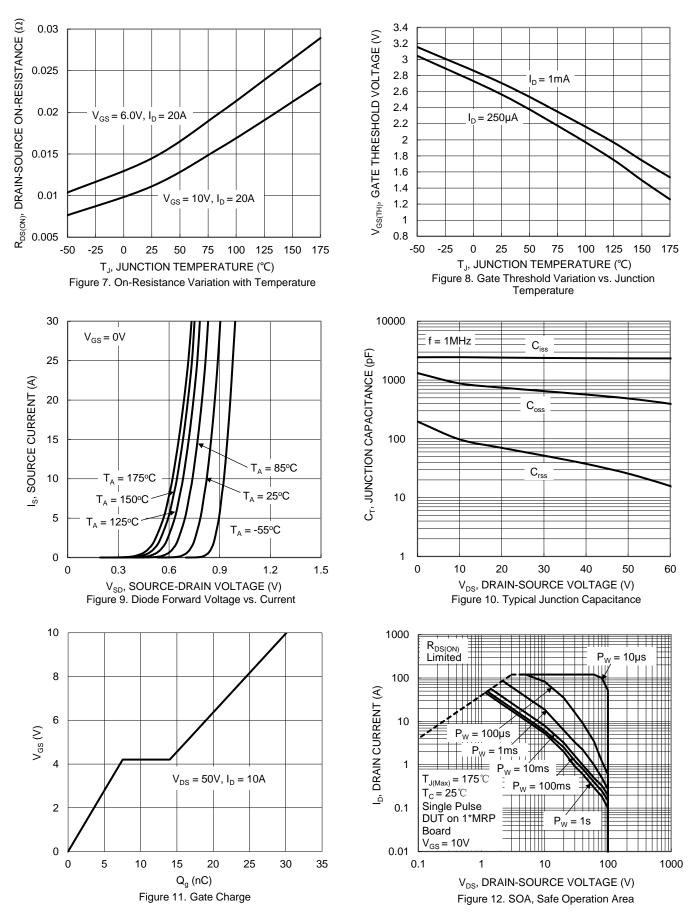
DMTH10H015SPS



DMTH10H015SPS Document number: DS39852 Rev. 4 - 2



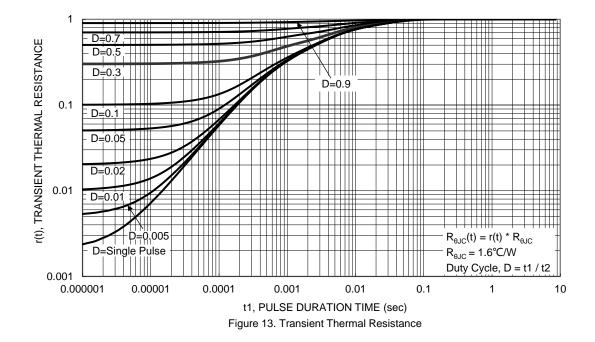
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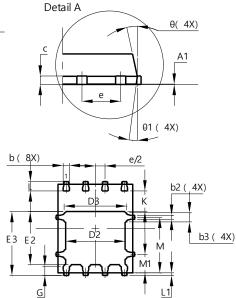




Package Outline Dimensions

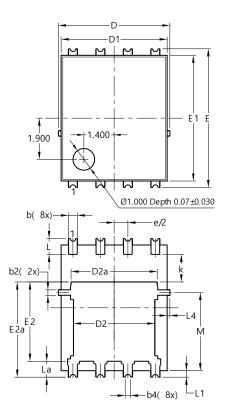
Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:



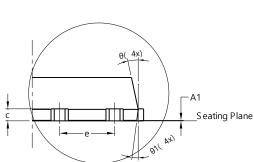
	PowerDI5060-8				
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC			
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	(6.15 BSC	;		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е		1.27 BSC			
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
Al	All Dimensions in mm				

Site 2:

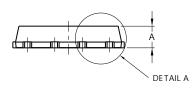


Detail A

PowerDI5060-8/SWP (Type UX)



DETAIL A



PowerDI5060-8/SWP (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	-	
c	0.230	0.330	0.277	
D	5	.15 BS0	2	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
E	6.40 BSC			
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1	.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0	.050RE	F	
L4	0.025	0.225	0.125	
Μ	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All	Dimensi	ions in	mm	

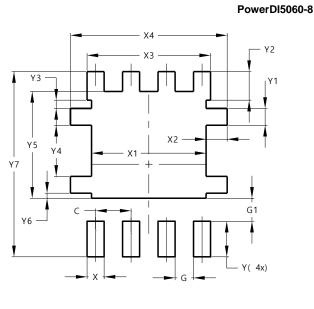
PowerDI5060-8



Suggested Pad Layout

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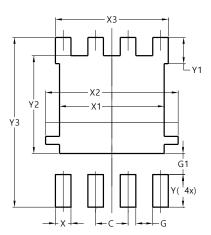
Site 1:



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	5.190
X3	4.420
Y	1.270
Y1	1.020
Y2	3.810
Y3	6.610



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